

# ESDA14V2-4BF1

# QUAD BIDIRECTIONAL TRANSIL™ ARRAY FOR ESD PROTECTION

## $A.S.D^{TM}$

#### **APPLICATIONS**

Where transient overvoltage protection in ESD sensitive equipment is required, such as :

- Computers
- Printers
- Communication systems and cellular phones
- Video equipment

This device is particularly adapted to the protection of symmetrical signals.

## **DESCRIPTION**

The ESDA14V2-4BF1 is a monolithic array designed to protect up to 4 lines in a bidirectional way against ESD transients.

The device is ideal for situations where board space saving is requested.

## **FEATURES**

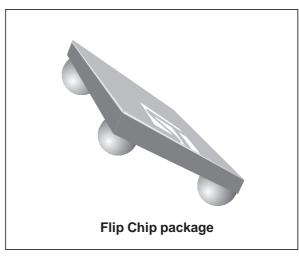
- 4 Bidirectional Transil<sup>TM</sup> functions
- ESD Protection: IEC61000-4-2 level 4
- Stand off voltage: 12 V MIN.
- Low leakage current < 1 μA</li>
- 50W Peak pulse power (8/20)

## **BENEFITS**

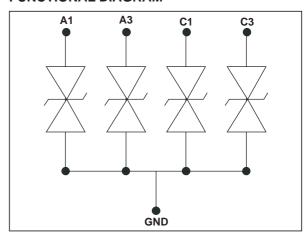
- High ESD protection level
- High integration
- Suitable for high density boards

## **COMPLIES WITH THE FOLLOWING STANDARDS:**

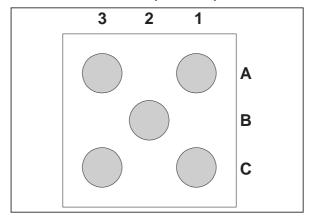
- IEC61000-4-2: 15 kV (air discharge) 8 kV (contact discharge)
- MIL STD 883E-Method 3015-7: class3 25kV (Human Body Model)



#### **FUNCTIONAL DIAGRAM**



**PIN CONFIGURATION (Ball Side)** 



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# ESDA14V2-4BF1

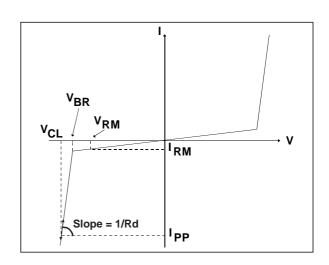
# **ABSOLUTE RATINGS** $(T_{amb} = 25^{\circ}C)$

Symbol	Test conditions	Value	Unit
V <sub>PP</sub>	ESD discharge - MIL STD 883E - Method 3015-7 IEC61000-4-2 air discharge IEC61000-4-2 contact discharge	±25 ±15 ±8	kV
P <sub>PP</sub>	Peak pulse power (8/20μs)	50	W
Tj	Junction temperature	125	°C
T <sub>stg</sub>	Storage temperature range	-55 to +150	°C
T <sub>L</sub>	Lead solder temperature (10 seconds duration)	260	°C
Top	Operating temperature range (note 1)	-40 to +125	°C

Note 1: Variation of parameters will be given in the final datasheet

# **ELECTRICAL CHARACTERISTICS** (T<sub>amb</sub> = 25°C)

Symbol	Parameter
V <sub>RM</sub>	Stand-off voltage
V <sub>BR</sub>	Breakdown voltage
V <sub>CL</sub>	Clamping voltage
I <sub>RM</sub>	Leakage current
I <sub>PP</sub>	Peak pulse current
С	Capacitance
Rd	Dynamic resistance

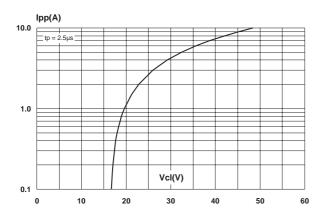


	VE	BR @	I <sub>R</sub>	I <sub>RM</sub> @	V <sub>RM</sub>	Rd	αΤ	С
Туре	min.	max.		max.		typ.	max.	max
Туре						note 1	note 2	0V bias
	V	V	mA	μΑ	V	Ω	10 <sup>-4</sup> /°C	pF
ECD 4.43/2 ADE4	44.0	4.0	_	1	12	0.0	40	4.5
ESDA14V2- 4BF1	14.2	18	1	0.1	3	3.2	10	15

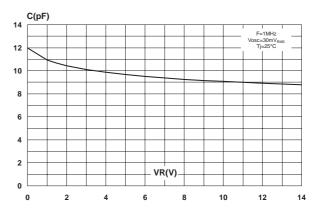
Note 1: Square pulse, IPP = 3A, tp =  $2.5\mu s$ Note 2:  $\Delta VBR = \alpha T(Tamb-25^{\circ}C) \times VBR(25^{\circ}C)$ 

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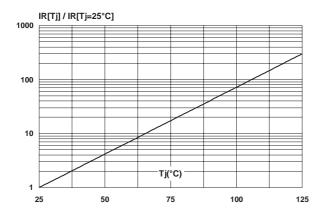
Fig. 1: Clamping voltage versus peak pulse current (Tj initial =  $25^{\circ}$ C) Rectangular waveform tp =  $2.5\mu$ s.



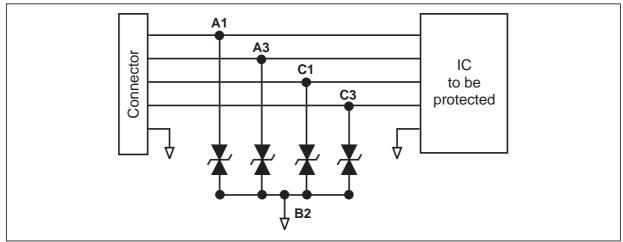
**Fig. 2:** Capacitance versus reverse applied voltage (typical values).



**Fig. 3:** Relative variation of leakage current versus junction temperature (typical values).



## **APPLICATION EXAMPLE**



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#### **TECHNICAL INFORMATION**

## 1. ESD protection by ESDA14V2- 4BF1

With the focus of lowering the operation levels, the problem of malfunction caused by the environment is critical. Electrostatic discharge (ESD) is a major cause of failure in electronic systems.

As a transient voltage suppressor, ESDA14V2-4BF1 is an ideal choice for ESD protection by suppressing ESD events. It is capable of clamping the incoming transient to a low enough level such that any damage is prevented on the device protected by ESDA14V2-4BF1.

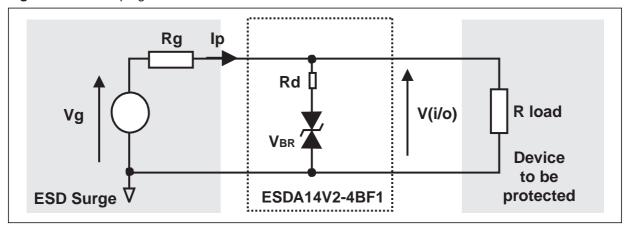
ESDA14V2-4BF1 serves as a parallel protection elements, connected between the signal line and ground. As the transient rises above the operating voltage of the device, the ESDA14V2-4BF1 becomes a low impedance path diverting the transient current to ground.

The clamping voltage is given by the following formula:

$$V_{CL} = V_{BR} + R_d.I_{pp}$$

As shown in figure A1, the ESD strikes are clamped by the transient voltage suppressor.

Fig. A1: ESD clamping behavior



To have a good approximation of the remaining voltages at both Vi/o side, we provide the typical dynamical resistance value Rd. By taking into account the following hypothesis:

we have:

$$V(i / o) = V_{BR} + R_d \times \frac{V_g}{R_g}$$

The results of the calculation done for  $V_g$  = 8 kV,  $R_g$  = 330  $\Omega$  (IEC 61000-4-2 standard),  $V_{BR}$  = 14.2 V (min.) and  $R_d$  = 3.2  $\Omega$  (typ.) give:

$$V(i/o) = 91.8 V$$

This confirms the very low remaining voltage across the device to be protected. It is also important to note that in this approximation the parasitic inductance effect was not taken into account. This could be a few tenths of volts during a few ns at the Vi/o side.

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V(i/o)

Fig. A2: ESD test board

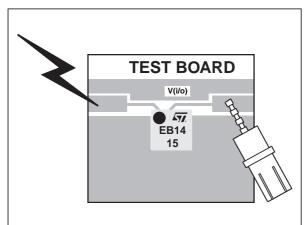
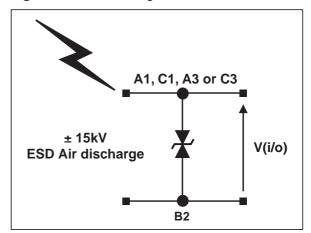
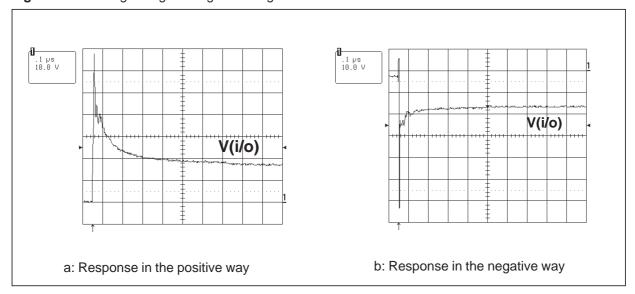


Fig. A3: ESD test configuration



The measurements done here after show very clearly (Fig. A4) the high efficiency of the ESD protection: the clamping voltage V(i/o) becomes very close to  $+V_{BR}$  (positive way, Fig. A4a) and  $-V_{BR}$  (negative way, Fig. A4b).

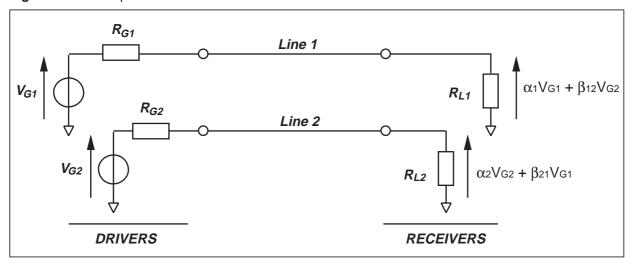
Fig. A4: Remaining voltage during ESD surge



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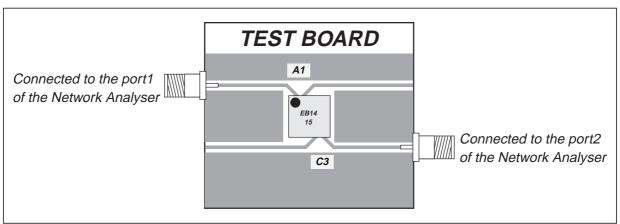
## **CROSSTALK BEHAVIOR**

Fig. A5: Crosstalk phenomenon



The crosstalk phenomena are due to the coupling between 2 lines. Coupling factors ( $\beta12$  or  $\beta21$ ) increase when the gap across lines decreases, particularly in silicon dice. In the example above, the expected signal on load  $R_{L2}$  is  $\alpha_2V_{G2}$ , in fact the real voltage at this point has got an extra value  $\beta_{21}V_{G2}$ . This part of the  $V_{G1}$  signal represents the effect of the crosstalk phenomenon of the line 1 on the line 2. This phenomenon has to be taken into account when the drivers impose fast digital data or high frequency analog signals. The perturbed line will be more affected if it works with low voltage signal or high load

Fig. A6: Analog crosstalk measurements



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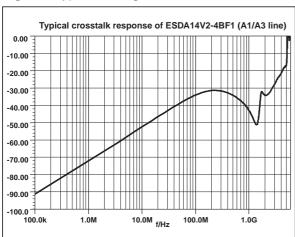


Fig. A7: Typical analog crosstalk measurements

Figure A6 gives the measurement circuit for the analog crosstalk application. In figure A7, the curve shows the effect of the line A1 on the line A3. In usual frequency range of analog signals (up to 100MHz) the effect on disturbed line is less than -30dB.

Fig. A8: Digital crosstalk measurements configuration.

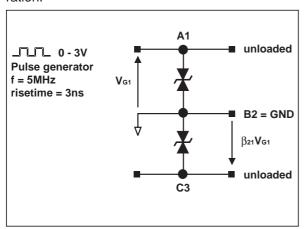


Fig. A9: Digital crosstalk results

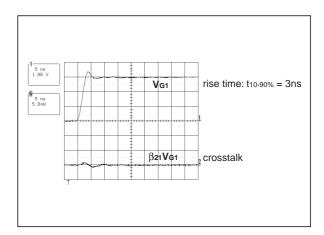
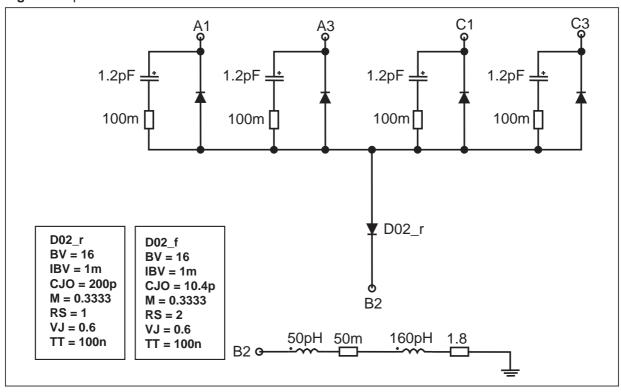


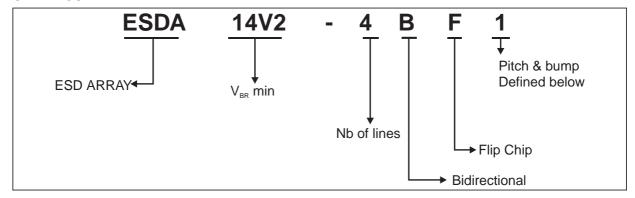
Figure A8 shows the measurement circuit used to quantify the crosstalk effect in a classical digital application.

Figure A9 shows that in such a condition, the impact on the disturbed line is less than 50 mV peak to peak. No data disturbance was noted on the concerned line. The measurements performed with falling edges give an impact within the same range.

Fig. A10: Aplac model



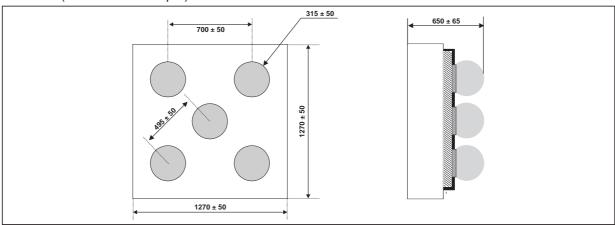
## **ORDER CODE**



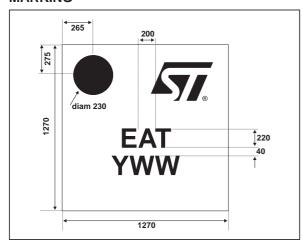
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## **PACKAGE MECHANICAL DATA**

DIE SIZE (all dimensions in µm)



## **MARKING**



YWW: Date code

## OTHER INFORMATION

Ordering code	Marking	Package	Weight	Base qty	Delivery mode
ESDA14V2-4BF1	EAT	Flip-Chip	2.1 mg	5000	Tape & reel 7"

**Note:** More packing informations are available in the application note AN1235: "Flip-Chip: Package description and recommandations for use"

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